



# MOSFET

# OptiMOS<sup>™</sup> 5 Power-Transistor, 80 V

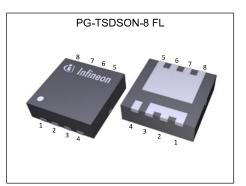
### **Features**

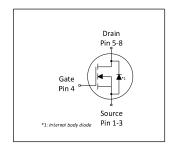
- Ideal for high frequency switching and sync. rec.
   Optimized technology for DC/DC converters
   Excellent gate charge x R<sub>DS(on)</sub> product (FOM)
   Very low on-resistance R<sub>DS(on)</sub>

- N-channel, normal level
- 100% avalanche tested
- Pb-free plating; RoHS compliant
  Qualified according to JEDEC<sup>1)</sup> for target applications
  Halogen-free according to IEC61249-2-21
- Higher solder joint reliability with enlarged source interconnection

#### Table 1 **Key Performance Parameters**

Parameter	Value	Unit	
V <sub>DS</sub>	80	V	
R <sub>DS(on),max</sub>	8.4	mΩ	
ID	64	A	
Q <sub>oss</sub>	25	nC	
Q <sub>G</sub> (0V10V)	20	nC	









Type / Ordering Code	Package	Marking	Related Links
BSZ084N08NS5	PG-TSDSON-8 FL	084N08N	-



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# **1 Maximum ratings** at *T*<sub>A</sub>=25 °C, unless otherwise specified

### Table 2Maximum ratings

	Oh. a l	Values			11	
Parameter	Symbol	Min.	Тур.	Max.	Unit	Note / Test Condition
Continuous drain current <sup>1)</sup>	I <sub>D</sub>	-	-	64 41	A	<i>T</i> <sub>C</sub> =25 °C <i>T</i> <sub>C</sub> =100 °C
Pulsed drain current <sup>2)</sup>	I <sub>D,pulse</sub>	-	-	256	A	<i>T</i> <sub>c</sub> =25 °C
Avalanche energy, single pulse <sup>3)</sup>	EAS	-	-	76	mJ	I <sub>D</sub> =20 A, R <sub>GS</sub> =25 Ω
Gate source voltage	V <sub>GS</sub>	-20	-	20	V	-
Power dissipation	Ptot	-	-	63	W	<i>T</i> <sub>c</sub> =25 °C
Operating and storage temperature	T <sub>j</sub> , T <sub>stg</sub>	-55	-	150	°C	IEC climatic category; DIN IEC 68-1: 55/150/56

#### **Thermal characteristics** 2

#### Table 3 **Thermal characteristics**

Devenueter	C. mah al	Values			11		
Parameter	Symbol	Min.	Тур.	Max.	Unit	Note / Test Condition	
Thermal resistance, junction - case	R <sub>thJC</sub>	-	1.2	2	K/W	-	
Device on PCB, 6 cm <sup>2</sup> cooling area <sup>4)</sup>	R <sub>thJA</sub>	-	-	60	K/W	-	

<sup>&</sup>lt;sup>1)</sup> Rating refers to the product only with datasheet specified absolute maximum values, maintaining case temperature as specified. For other case temperatures please refer to Diagram 2. De-rating will be required based on the actual <sup>2)</sup> See Diagram 3 for more detailed information
 <sup>3)</sup> See Diagram 13 for more detailed information

<sup>&</sup>lt;sup>4)</sup> Device on 40 mm x 40 mm x 1.5 mm epoxy PCB FR4 with 6 cm<sup>2</sup> (one layer, 70 µm thick) copper area for drain connection. PCB is vertical in still air.



# **3** Electrical characteristics at *T*<sub>j</sub>=25 °C, unless otherwise specified

#### Table 4 **Static characteristics**

Parameter	Symphol		Values			Note / Toot Condition
Parameter	Symbol	Min.	Тур.	Max.	Unit	Note / Test Condition
Drain-source breakdown voltage	V <sub>(BR)DSS</sub>	80	-	-	V	V <sub>GS</sub> =0 V, <i>I</i> <sub>D</sub> =1 mA
Gate threshold voltage	V <sub>GS(th)</sub>	2.2	3.0	3.8	V	$V_{\rm DS}=V_{\rm GS}, I_{\rm D}=31~\mu {\rm A}$
Zero gate voltage drain current	I <sub>DSS</sub>	-	0.1 10	1 100	μA	V <sub>DS</sub> =80 V, V <sub>GS</sub> =0 V, T <sub>j</sub> =25 °C V <sub>DS</sub> =80 V, V <sub>GS</sub> =0 V, T <sub>j</sub> =125 °C
Gate-source leakage current	I <sub>GSS</sub>	-	1	100	nA	V <sub>GS</sub> =20 V, V <sub>DS</sub> =0 V
Drain-source on-state resistance	R <sub>DS(on)</sub>	-	7.1 9.9	8.4 11.9	mΩ	V <sub>GS</sub> =10 V, <i>I</i> <sub>D</sub> =20 A V <sub>GS</sub> =6 V, <i>I</i> <sub>D</sub> =5 A
Gate resistance	R <sub>G</sub>	-	1.2	1.8	Ω	-
Transconductance	$g_{ m fs}$	20	39	-	S	V <sub>DS</sub>  >2 I <sub>D</sub>  R <sub>DS(on)max</sub> , I <sub>D</sub> =20 A

## Table 5Dynamic characteristics

Parameter	Course had		Values			
	Symbol	Min.	Тур.	Max.	Unit	Note / Test Condition
Input capacitance <sup>1)</sup>	Ciss	-	1400	1820	pF	V <sub>GS</sub> =0 V, V <sub>DS</sub> =40 V, <i>f</i> =1 MHz
Output capacitance <sup>1)</sup>	Coss	-	240	312	pF	V <sub>GS</sub> =0 V, V <sub>DS</sub> =40 V, <i>f</i> =1 MHz
Reverse transfer capacitance <sup>1)</sup>	C <sub>rss</sub>	-	13	22.8	pF	V <sub>GS</sub> =0 V, V <sub>DS</sub> =40 V, <i>f</i> =1 MHz
Turn-on delay time	t <sub>d(on)</sub>	-	13	-	ns	$V_{\rm DD}$ =40 V, $V_{\rm GS}$ =10 V, $I_{\rm D}$ =20 A, $R_{\rm G,ext}$ =1.6 $\Omega$
Rise time	tr	-	5	-	ns	$V_{\rm DD}$ =40 V, $V_{\rm GS}$ =10 V, $I_{\rm D}$ =20 A, $R_{\rm G,ext}$ =1.6 $\Omega$
Turn-off delay time	t <sub>d(off)</sub>	-	25	-	ns	$V_{\rm DD}$ =40 V, $V_{\rm GS}$ =10 V, $I_{\rm D}$ =20 A, $R_{\rm G,ext}$ =1.6 $\Omega$
Fall time	t <sub>f</sub>	-	5	-	ns	$V_{\rm DD}$ =40 V, $V_{\rm GS}$ =10 V, $I_{\rm D}$ =20 A, $R_{\rm G,ext}$ =1.6 $\Omega$

#### Table 6 Gate charge characteristics<sup>2)</sup>

	Currente e l		Values			
Parameter	Symbol	Min.	Тур.	Max.	Unit	Note / Test Condition
Gate to source charge	Q <sub>gs</sub>	-	6.5	-	nC	$V_{DD}$ =40 V, $I_{D}$ =20 A, $V_{GS}$ =0 to 10 V
Gate to drain charge <sup>1)</sup>	Q <sub>gd</sub>	-	4.4	7	nC	$V_{DD}$ =40 V, $I_{D}$ =20 A, $V_{GS}$ =0 to 10 V
Switching charge	Q <sub>sw</sub>	-	7.1	-	nC	$V_{DD}$ =40 V, $I_{D}$ =20 A, $V_{GS}$ =0 to 10 V
Gate charge total <sup>1)</sup>	Qg	-	20	25	nC	$V_{DD}$ =40 V, $I_{D}$ =20 A, $V_{GS}$ =0 to 10 V
Gate plateau voltage	V <sub>plateau</sub>	-	4.7	-	V	$V_{DD}$ =40 V, $I_{D}$ =20 A, $V_{GS}$ =0 to 10 V
Gate charge total, sync. FET	Q <sub>g(sync)</sub>	-	17	-	nC	V <sub>DS</sub> =0.1 V, V <sub>GS</sub> =0 to 10 V
Output charge <sup>1)</sup>	Q <sub>oss</sub>	-	25	33	nC	V <sub>DD</sub> =40 V, V <sub>GS</sub> =0 V

 <sup>&</sup>lt;sup>1)</sup> Defined by design. Not subject to production test.
 <sup>2)</sup> See "Gate charge waveforms" for parameter definition.



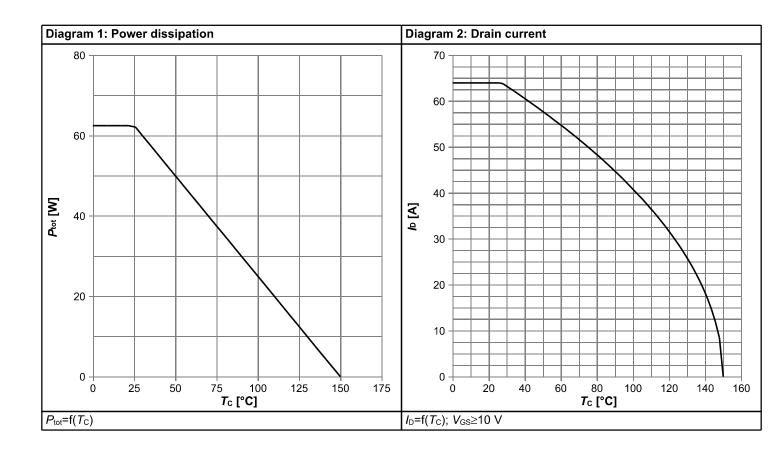
## Table 7Reverse diode

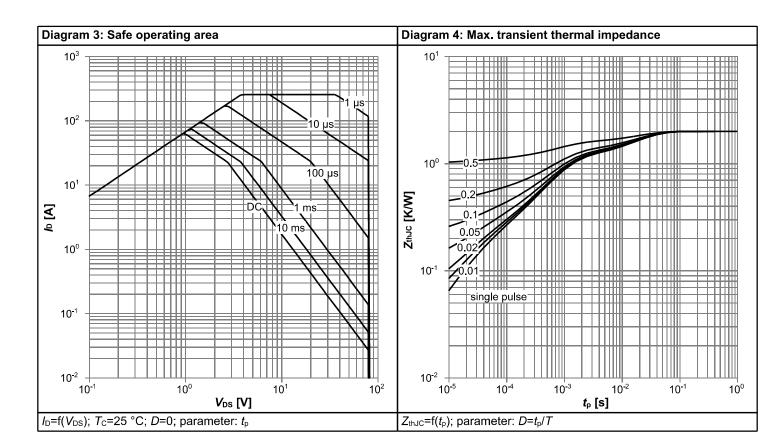
Parameter	Symbol		Values			
	Symbol	Min.	Тур.	Max.	Unit	Note / Test Condition
Diode continous forward current	Is	-	-	46	А	<i>T</i> <sub>C</sub> =25 °C
Diode pulse current	I <sub>S,pulse</sub>	-	-	256	А	<i>T</i> <sub>C</sub> =25 °C
Diode forward voltage	V <sub>SD</sub>	-	0.86	1.2	V	$V_{GS}=0$ V, $I_{F}=20$ A, $T_{J}=25$ °C
Reverse recovery time <sup>1)</sup>	t <sub>rr</sub>	-	38	76	ns	V <sub>R</sub> =40 V, I <sub>F</sub> =20 A, di <sub>F</sub> /dt=100 A/μs
Reverse recovery charge <sup>1)</sup>	Qrr	-	44	88	nC	V <sub>R</sub> =40 V, <i>I</i> <sub>F</sub> =20 A, d <i>i</i> <sub>F</sub> /d <i>t</i> =100 A/μs

<sup>&</sup>lt;sup>1)</sup> Defined by design. Not subject to production test.

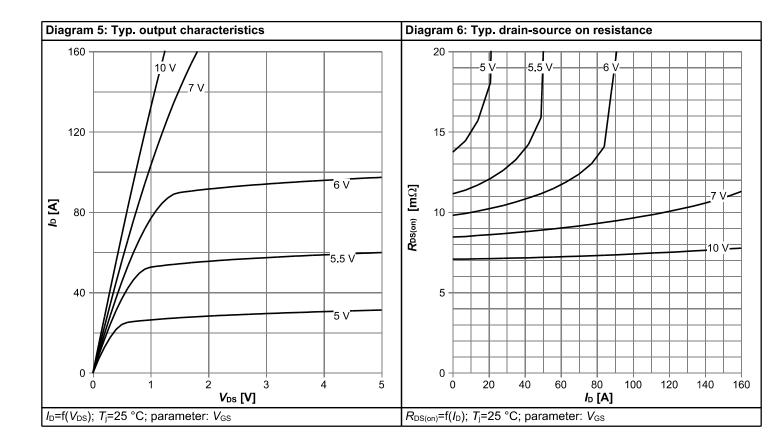


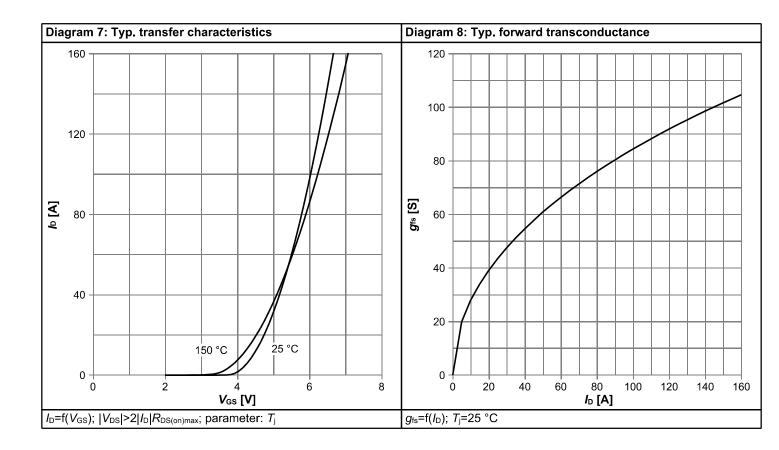
# 4 Electrical characteristics diagrams



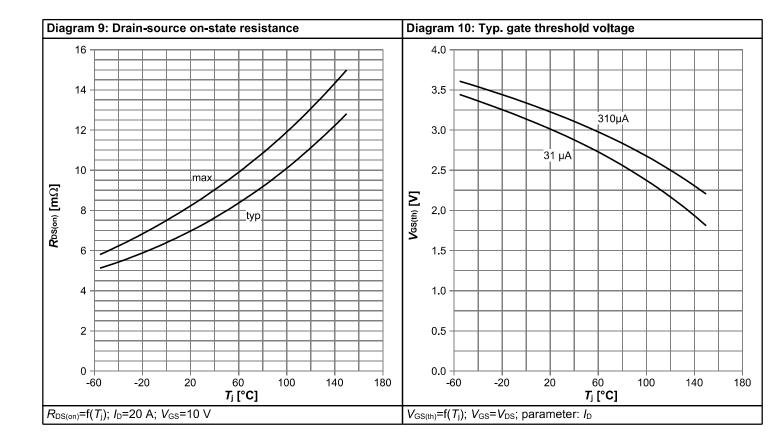


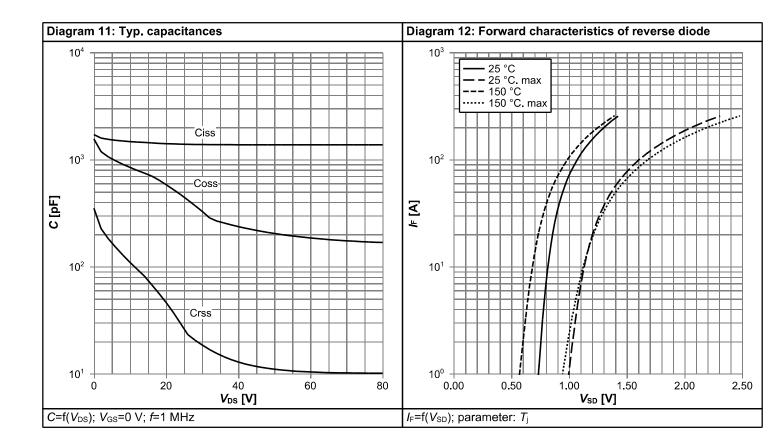




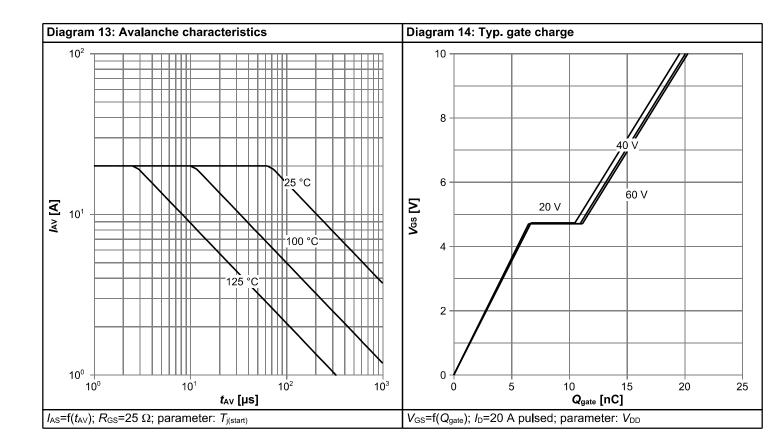


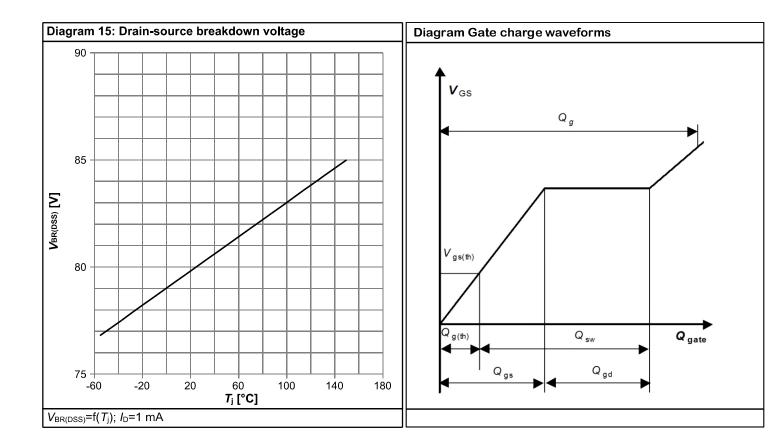






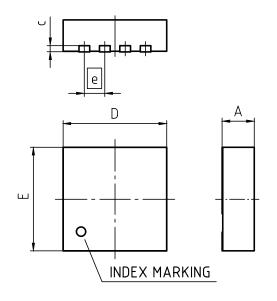


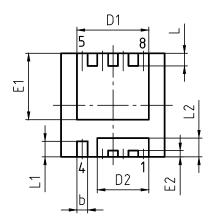






# 5 Package Outlines





PACKAGE - GROUP NUMBER:	ON-8-U03					
<b>REVISION: 03</b>	DATE:	20.10.2020				
DIMENSIONS	MILLIM	ETERS				
DIMENSIONS	MIN.	MAX.				
A	0.90	1.10				
b	0.24	0.44				
c	(0.20)					
D	3.20	3.40				
D1	2.19	2.39				
D2	1.54	1.74				
E	3.20	3.40				
E1	2.01	2.21				
E2	0.10	0.30				
е	0.65					
L	0.30	0.50				
L1	0.40 0.60					
L2	0.50 0.70					
aaa	0.0	)6				

# Figure 1 Outline PG-TSDSON-8 FL, dimensions in mm



### **Revision History**

BSZ084N08NS5

### Revision: 2021-06-23, Rev. 2.2

Previous Revision						
Revision	Date	Subjects (major changes since last revision)				
2.0	2014-12-17	Release of final version				
2.1	2020-11-09	Update package drawing, footnotes and Diagram 13				
2.2	2021-06-23	Update Id max current rating				

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